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RECTANGULAR POWER CONNECTORS



PRODUCT DRAWING

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TE CONNECTIVITY (TE) MICRO MNL HDR ASSY S/ROW LF MATE-N-LOK | Micro MATE-N-LOK

2-1445054-3 TE Internal Number: 2-1445054-3

Always EU RoHS/ELV Compliant

Product Type Header			
Housing Type Plug			
Connector System Wire-to-Board			
Applies To Printed Circuit Board			
Contact Current Rating (A) 5			

Product Drawings	RIGHT ANGLE THRU HOLE HEADER ASSY, TIN CONTACTS W/THRU HOLE HOLDDOWNS, SINGLE RO PDF English
CAD Files	Customer View Model 2D_DXF.ZIP English
	3D PDF PDF 3D
	Customer View Model 3D_IGS.ZIP English
	Customer View Model 3D_STP.ZIP English
Catalog Pages/Data Sheets	SOFT_SHELL_PIN_AND_SOCKET_CONNECTORS_CATALOG PDF English
	1773458-4_MICRO_MATE_N_LOK_CONNECTOR_SYSTEM_QRG PDF English
Product Specifications	
Application Specification	Micro MATE-N-LOK Connectors PDF English
Application Specification	PDF

Product Environmental Compliance

TE Material Declaration

MD_2-1445054-3_050420142257_dmtec PDF English

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C A Contact Current Rating (A) ${\rm 5}$ Please review product documents or **contact us** for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features Product Type Header Housing Type Plug Contact Type Pin Configuration Features Number of Positions 3 Centerline 3 mm [.1] PCB Mounting Orientation Right Ar Number of Rows 1 Multiple Contact Types Without Contact Layout Inline Electrical Characteristics Contact Current Rating (A) 5 Operating Voltage (VAC) 250 Operating Voltage (VAC) 250 Contact Features Contact Retention Termination Area Plating Material Tin Contact Termination Area Plating Material Tin Contact Termination Area Plating Thickness 2.54 µm Termination Peatures Termination Method to Wire/Cable Solder Termination Retord to PC Board Through Termination Retord to PC Board Through Mechanical Attachment Mating Alignment With Mating Retention With	
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Mechanical Attachment Mating Alignment With Mating Retention With	Hole - Solder
Mating Retention With	.125 in]
PCB Mount Retention With	
PCB Mount Retention Type Boardlo	
Mating Alignment Type Polariza	ks
Mating Retention Type Locking	
Panel Mount Retention Without	ion
Strain Relief Without	ion
Housing Features UL Flammability Rating UL 94V-	ion
Housing Color Black	ion Fab

	Housing Material Boardlock Material	High Temperature Nylon Phosphor Bronze
Dimensions	Accepts Wire Insulation Diameter Range (mm)	1.52
	Width (mm)	3.86
	Height (mm)	10.43
	PCB Thickness (Recommended)	1.57 mm [.062 in]
	Length (mm)	10.14
Usage Conditions	Sealed Condition	Not Sealed
Operation/Application	Connector System	Wire-to-Board
	Applies To	Printed Circuit Board
	Operating Temperature	-40 – 105 °C [-40 – 221 °F]
Industry Standards	VDE Tested	Yes
	CSA Rating	Certified
	Agency/Standard Number	E28476
	UL Rating	Recognized
	CSA File Number	LR7189
	Agency/Standard	CSA, UL
Packaging Features	Packaging Method	Tray, Tray/Box
	Packaging Quantity	266
Product Compliance	Statement of Compliance	

Product Compliance

Statement of Compliance PDF

VIEW ALL PRODUCT COMPLIANCE

CUSTOMERS ALSO BOUGHT

STANDARD RECTANGULAR CONNECTORS	RECTANGULAR POWER CONNECTORS	MULTIPLE CONFIGURATION PCB HEADERS & RECEPTACLES	RECTANGULAR POWER CONNECTORS	
6POS MICRO MNL ASSY,	09P MR II CAP HSG V0 RED	24 MODII HDR DRST SHRD	FREE HANG DBL ROW	>
VRT, THRU 794682-6	1-640511-0	.100CL 6-103168-0	HSG 20 POS 2-794616-0	
		6-103168-0	2-794616-0	

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Products - 1 Results			View All	Compare 0/10	
Relation Type	•				
RELATIONSHIP Mating Products					
Used to identify Mating Parts				See All Mating Prod	ucts
	PRODUCT - MATING PRODUCTS				~
1	Connectors - Rectangular Power MATE-N-LOK Micro MATE-N-LOK MICRO MNL RFE		s EU RoHS/ELV Co	ompliant └	
NALS 1	HSG SINGLE R				
	- 1445022-3 TE INTERNAL NUMBER: 1445022-3				

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